

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Lin et al.	Docket No.: TI-31518
Serial No: TBD	Examiner: TBD
Filed: 10/11/01	Art Unit: TBD
For: ELIMINATION OF OVERHANG IN LINER/BARRIER/SEED LAYERS USING POST-DEPOSITION SPUTTER ETCH	

PRELIMINARY AMENDMENT

October 11, 2001

Assistant Commissioner for Patents

Washington, DC 20231

Dear Sir:

Please amend the above referenced application as follows:

In the Specification:

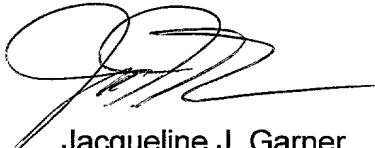
Page 1, before line 1, insert --This application claims priority under 35 USC § 119(e)(1) of provisional application numbers 60/249,106 filed 11/16/00.--

## REMARKS

Entry of the foregoing amendment prior to examination is respectfully requested.

If the Examiner has any questions or other correspondence regarding this application, Applicant requests that the Examiner contact Applicant's attorney at the below listed telephone number and address.

Respectfully submitted,



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